

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No. 10/666,399

Confirmation No. 8955

Applicant: Michael S. Leung Filed: September 18, 2003

Art Unit: 2814

Examiner: Thao X. Le
Attorney Doc. P0298US-7

Title: MOLDED CHIP FABRICATION METHOD AND APPARATUS

Mail Stop RCE Commissioner for Patents P.O. Box 1450 Alexandria VA 22313-1450

RESPONSE TO FINAL OFFICE ACTION AND REQUEST FOR CONTINUED EXAMINATION

Dear Sir:

The following is in response to the final office action mailed May 13, 2005 and is filed concurrently with a Request for Continued Examination:

Amendments to the claims are reflected in the listing of which begins on page 2 of this paper.

Remarks begin on page 9 of this paper.

Enterel W/RCG 8/15/05